



YUSO-131

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of) Art Unit: 2818
Hsieh et al.)
Serial No.: 10/052,989) Examiner: David Vu
Filing Date: November 9, 2001)
For: Formation of Electroplate)
Solder on an Organic Circuit)
Board for Flip Chip Joints and)
Board to Board Solder Joints)

Mail Stop After Final
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

OK to enter AMENDMENT TO FINAL OFFICE ACTION DATED MARCH 3, 2006

DV In response to the Final Office Action dated March 3, 2006, please enter and
04/11/06 consider the following amendments and remarks: